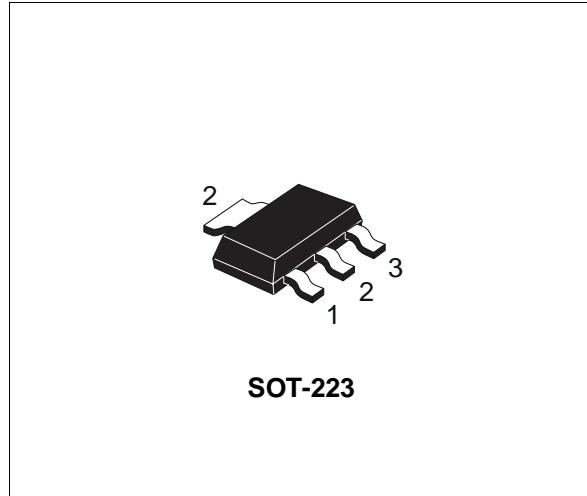


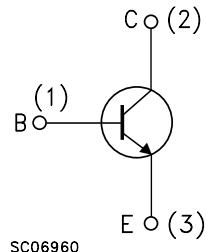
## MEDIUM POWER AMPLIFIER

ADVANCE DATA

- SILICON EPITAXIAL PLANAR NPN TRANSISTORS
- MINIATURE PLASTIC PACKAGE FOR APPLICATION IN SURFACE MOUNTING CIRCUITS
- GENERAL PURPOSE MAINLY INTENDED FOR USE IN MEDIUM POWER INDUSTRIAL APPLICATION AND FOR AUDIO AMPLIFIER OUTPUT STAGE
- PNP COMPLEMENTS ARE BSP30, BSP31, BSP32 AND BSP33 RESPECTIVELY



INTERNAL SCHEMATIC DIAGRAM



### ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value		Unit
		BSP40/BSP41	BSP42/BSP43	
$V_{CBO}$	Collector-Base Voltage ( $I_E = 0$ )	70	90	V
$V_{CEO}$	Collector-Emitter Voltage ( $I_B = 0$ )	60	80	V
$V_{CES}$	Collector-Emitter Voltage ( $V_{BE} = 0$ )	70	90	V
$V_{EBO}$	Emitter-Base Voltage ( $I_C = 0$ )	5		V
$I_C$	Collector Current	1		A
$I_B$	Base Current	0.1		A
$P_{tot}$	Total Dissipation at $T_c = 25^\circ\text{C}$	2		W
$T_{stg}$	Storage Temperature	-65 to 150		$^\circ\text{C}$
$T_j$	Max. Operating Junction Temperature	150		$^\circ\text{C}$

## BSP40/41/42/43

### THERMAL DATA

$R_{thj\text{-amb}}$	Thermal Resistance Junction-Ambient	Max	62.5	$^{\circ}\text{C}/\text{W}$
$R_{thj\text{-tab}}$	Thermal Resistance Junction-Collecor Tab	Max	8	$^{\circ}\text{C}/\text{W}$

• Mounted on a ceramic substrate area = 30 x 35 x 0.7 mm

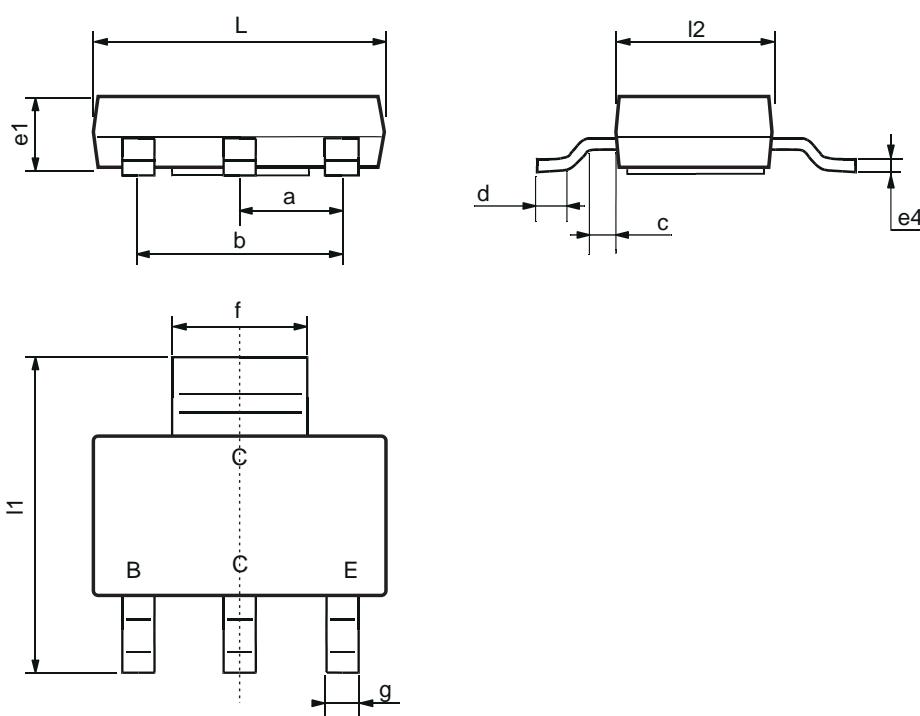
### ELECTRICAL CHARACTERISTICS ( $T_{\text{case}} = 25^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$I_{\text{CBO}}$	Collector Cut-off Current ( $I_E = 0$ )	$V_{\text{CB}} = 60 \text{ V}$ $V_{\text{CB}} = 60 \text{ V} \quad T_j = 150^{\circ}\text{C}$			100 50	nA $\mu\text{A}$
$V_{(\text{BR})\text{CBO}}$	Collector-Base Breakdown Voltage ( $I_E = 0$ )	$I_C = 100 \mu\text{A}$ for <b>BSP40/BSP41</b> for <b>BSP42/BSP43</b>	70 90			V V
$V_{(\text{BR})\text{CEO}}^*$	Collector-Emitter Breakdown Voltage ( $I_B = 0$ )	$I_C = 10 \text{ mA}$ for <b>BSP40/BSP41</b> for <b>BSP42/BSP43</b>	60 80			V V
$V_{(\text{BR})\text{CES}}$	Collector-Emitter Breakdown Voltage ( $V_{\text{BE}} = 0$ )	$I_C = 10 \mu\text{A}$ for <b>BSP40/BSP41</b> for <b>BSP42/BSP43</b>	70 90			V V
$V_{(\text{BR})\text{EBO}}$	Emitter-Base Breakdown Voltage ( $I_C = 0$ )	$I_C = 10 \mu\text{A}$	5			V
$V_{\text{CE}(\text{sat})}^*$	Collector-Emitter Saturation Voltage	$I_C = 150 \text{ mA} \quad I_B = 15 \text{ mA}$ $I_C = 500 \text{ mA} \quad I_B = 50 \text{ mA}$			0.25 0.5	V V
$V_{\text{BE}(\text{sat})}^*$	Base-Emitter Saturation Voltage	$I_C = 150 \text{ mA} \quad I_B = 15 \text{ mA}$ $I_C = 500 \text{ mA} \quad I_B = 50 \text{ mA}$			1 1.2	V V
$h_{\text{FE}}^*$	DC Current Gain	for <b>BSP40/BSP41</b> $I_C = 100 \mu\text{A} \quad V_{\text{CE}} = 5 \text{ V}$ $I_C = 100 \text{ mA} \quad V_{\text{CE}} = 5 \text{ V}$ $I_C = 500 \text{ mA} \quad V_{\text{CE}} = 5 \text{ V}$ for <b>BSP42/BSP43</b> $I_C = 100 \mu\text{A} \quad V_{\text{CE}} = 5 \text{ V}$ $I_C = 100 \text{ mA} \quad V_{\text{CE}} = 5 \text{ V}$ $I_C = 500 \text{ mA} \quad V_{\text{CE}} = 5 \text{ V}$	10 40 30 30 100 50		120 300	
$f_T$	Transition Frequency	$I_C = 50 \text{ mA} \quad V_{\text{CE}} = 10 \text{ V} \quad f = 35 \text{ MHz}$	100			MHz
$C_{\text{CBO}}$	Collector-Base Capacitance	$I_E = 0 \quad V_{\text{CB}} = 10 \text{ V} \quad f = 1 \text{ MHz}$			20	pF
$C_{\text{EBO}}$	Emitter-Base Capacitance	$I_C = 0 \quad V_{\text{EB}} = 0.5 \text{ V} \quad f = 1 \text{ MHz}$			90	pF
$t_{\text{on}}$	Turn-on Time	$I_C = 100 \text{ mA} \quad I_{B1} = -I_{B2} = 5 \text{ mA}$			250	ns
$t_{\text{off}}$	Turn-on Time				1000	ns

\* Pulsed: Pulse duration = 300  $\mu\text{s}$ , duty cycle  $\leq 1.5\%$

### SOT223 MECHANICAL DATA

DIM.	mm			mils		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
a	2.27	2.3	2.33	89.4	90.6	91.7
b	4.57	4.6	4.63	179.9	181.1	182.3
c	0.2	0.4	0.6	7.9	15.7	23.6
d	0.63	0.65	0.67	24.8	25.6	26.4
e1	1.5	1.6	1.7	59.1	63	66.9
e4			0.32			12.6
f	2.9	3	3.1	114.2	118.1	122.1
g	0.67	0.7	0.73	26.4	27.6	28.7
l1	6.7	7	7.3	263.8	275.6	287.4
l2	3.5	3.5	3.7	137.8	137.8	145.7
L	6.3	6.5	6.7	248	255.9	263.8



P008B

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